SCAS003A - D2957, JUNE 1987 - REVISED APRIL 1993

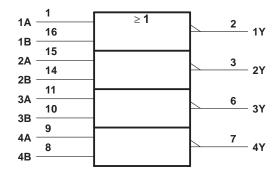
- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture to Optimize PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

These devices contain four independent 2-input NOR gates. They perform the Boolean functions $Y = \overline{A} \cdot \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The 54ACT11002 is characterized for operation over the full military temperature range of -55° C to 125°C. The 74ACT11002 is characterized for operation from -40° C to 85° C.

logic symbol†



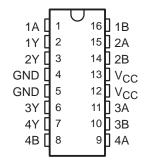
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

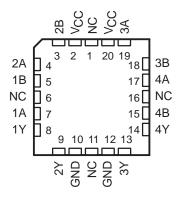
FUNCTION TABLE (each gate)

INP	JTS	OUTPUT
Α	В	Y
Н	Χ	L
X	Н	L
L	L	Н

54ACT11002 ... J PACKAGE 74ACT11002 ... D OR N PACKAGE (TOP VIEW)

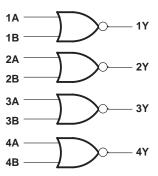


54ACT11002 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

recommended operating conditions

		54ACT11002		74ACT11002		UNIT
		MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
ІОН	High-level output current		-24		-24	mA
lOL	Low-level output current		24		24	mA
Δt /Δν	Input transition rise or fall rate	0	10	0	10	ns/V
TA	Operating free-air temperature	-55	125	- 40	85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	T _A = 25°C			54ACT11002		74ACT11002		UNIT	
PARAMETER		VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX 4 4 8 8 0.1 0.1 0.44 0.44 1.65	UNII	
VOH	I _{OH} = - 50 μA	4.5 V	4.4			4.4		4.4		· V	
	10H = - 20 ltv	5.5 V	5.4			5.4		5.4			
	I _{OH} = -24 mA	4.5 V	3.94			3.7		3.8			
		5.5 V	4.94			4.7		4.8			
	$I_{OH} = -50 \text{ mA}^{\ddagger}$					3.85					
	I _{OH} = -75 mA [‡]	5.5 V						3.85			
	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	V	
V _{OL}		5.5 V			0.1		0.1		0.1		
	I _{OL} = 24 mA	4.5 V			0.36		0.5		0.44		
		5.5 V			0.36		0.5		0.44		
	I _{OL} = 50 mA [‡]	5.5 V					1.65				
	I _{OL} = 75 mA [‡]	5.5 V							1.65		
lį	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1		± 1	μΑ	
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		80		40	μΑ	
ΔI _{CC} §	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1		1	mA	
C _i	V _I = V _{CC} or GND	5 V		3.5					·	pF	

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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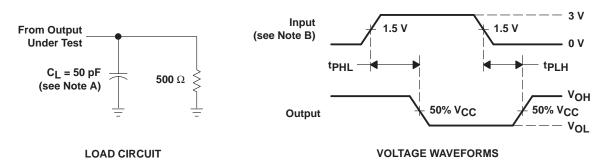
switching characteristics over recommended ranges of supply voltage and free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C			54ACT11002		74ACT11002		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONII
t _{PLH}	A or B	Υ	1.5	6.1	9.4	1.5	11.3	1.5	10.6	
t _{PHL}			1.5	5.3	7.8	1.5	9.5	1.5	8.7	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per gate	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	29	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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